IN THE CLAIMS

Claim 1-17 (canceled)

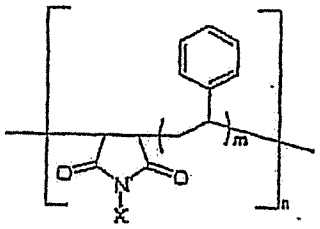
Claim 18 (currently amended) A Polyamide molding material for highly glossy, rigid polyamide molded bodies containing

A) 100 parts of a polyamide mixture made of

a) 0.5-95% by weight of a semicrystalline linear polyamide,

b) 5-99% by weight of a branched graft polyamide

b.1.) made of a styrene maleinimide basic structure of the general formula 1



-m standing for 1-5 and -n for 3-15, and the molecular weight of the basic structure unit being between 600 and 9000 g/mol and polyamine acid chains are grafted on at the position X and/or

b.2.) obtained via hydrolytic polymerization of amino acids and/or lactams as basic building blocks, where components with a branching effect being added to the melt of the basic building blocks in the following compositions:

b.2.1.) 5-150 µmol/g of the polymer of an at least tri-functional monomer comprising an amine or a carboxylic acid, and

b.2.2.) 2-100 µmol/g of the polymer of an at least bi-functional monomer comprising a carboxylic acid, if b.2.1.) is an amine, or comprising an amine, if b.2.1.) is a carboxylic acid,

c) 0.5-40% by weight of an amorphous polyamide and

d) 0-2% by weight of carbon black, a + b + c + d together producing 100% by weight and

B) 40-235 parts reinforcing materials and

C) additives normal for polyamide molding materials.

Claim 19 (previously presented) The polyamide molding material according to claim 18, wherein the polyamide mixture A) contains 0.5-80% by weight of the semicrystalline linear polyamide a), 15-98.5% by weight of the branched graft polyamide b), 1-35% by weight of amorphous polyamide c) and 0-2% by weight of carbon black d).

Claim 20 (previously presented) The polyamide molding material according to claim 19, wherein the polyamide mixture contains 1-64.5% by weight of the semicrystalline linear polyamide a), 18-79.5% by weight of the branched graft polyamide b), 20-35% by weight of amorphous polyamide c) and 0.5-2% by weight of carbon black d).

Claim 21 (previously presented) The polyamide molding material according to claim 18, wherein it has,at processing temperatures, melt viscosities with shear rates of γ = 200/s < 300 Pas and at γ = 1000 s < 150 Pas.

Claim 22 (currently amended) The polyamide molding material according to claim 18, wherein the semicrystalline linear polyamide a) is selected from PA6, PA66, PA12, PA6T, PA6T12, PA12T~~, whereas the terephthalic acid (T) could be replaced partially by isophthalic acid (I) or adipinic acid or mixtures thereof~~.

Claim 23 (currently amended) The polyamide molding material according to claim 18, wherein the graft polyamides ~~b) are used, which are derived from PA6, PA11, PA12 and~~ have more than 3 arms and the polyamino acid chains of b.1) and/or the basic building block of b.2) represent a polyamide selected from the group consisting of PA6, PA11, PA12.

Claim 24 (previously presented) The polyamide molding material according to claim 18, wherein the graft polyamides b) have a relative viscosity (1% in H2S04, 23°C) < 2.2 and a melt viscosity (γ = 500/s) < 50 Pas 30°C above the melting temperature.

Claim 25 (currently amended) The polyamide molding material according to claim 24, wherein the graft polyamide b) contains ~~inherent~~ slip additives.

Claim 26 (previously presented) The polyamide molding material according to claim 18, wherein the polyamides b) have a molecular weight distribution (GPC/standard polystyrene) which corresponds approximately to the distribution of the semicrystalline polyamide a).

Claim 27 (currently amended) The polyamide molding material according to claim 18, wherein the amorphous polyamide c) is selected from PA MACM12, PA PACM12, or mixtures/copolyamides thereof and PA61, PAMXDI, PA 6I/MXDI, ~~whereas isophthalic acid (I) could be replaced partially by terephthalic acid (T) or adipinic acid and MXDA partially by PXDA~~.

Claim 28 (currently amended) The polyamide molding material according to claim 27, wherein the amorphous polyamide c) is selected from PA6I/6T, ~~and/or~~ PAMXDI/MXDT/6I/6T or mixtures thereof.

Claim 29 (currently amended) The polyamide molding material according to claim 18, wherein the reinforcing materials B) are selected from the group consisting of: glass fibers, carbon fibers, minerals ~~such as talc, mica, kaolin, wollastonite~~, nanocomposites, whiskers and further reinforcing materials which are common for polyamide or mixtures thereof.

Claim 30 (previously presented) The polyamide molding material according to claim 18, wherein the polyamide molding material A) contains common additives C).

Claim 31 (currently amended) The polyamide molding material according to claim ~~13~~ 18, wherein the additives C) are selected from impact strength modifiers, ~~UV-heat- and processing~~ UV-heat-stabilizers, processing stabilizers and slip additives which can also be contained inherently in the graft polyamide.

Claim 32 (previously presented) The molded articles produced with molding materials according to claim 18, wherein the molded articles have an outstanding surface quality, expressed by the surface gloss at an angle of 60°, greater than 75.

Claim 33 (currently amended) A method of producing a molded article from the molding material according to claim 18 comprising utilizing injection molding, extrusion, extrusion blow-molding, gas injection technology ~~GIT~~, water injection technology ~~WIT~~, micro-injection molding, injection blowing, pultrusion or deep drawing.

Claim 34 (previously presented) The polyamide molding material according to claim 25, wherein the slip additives comprise long-chained n-alkylenes.

Claim 35 (new) The polyamide molding material according to claim 22, wherein the terephthalic acid (T) is partially replaced by isophthalic acid (I) or adipinic acid or mixtures thereof

Claim 36 (new) The polyamide molding material according to claim 27, wherein the isophthalic acid (I) is partially replaced by terephthalic acid (T) or adipinic acid and MXDA partially by PXDA.

Claim 37 (new) The polyamide molding material according to claim 29, wherein the minerals comprise at least one of talc, mica, kaolin and wollastonite.